Integrated 4-, 6- and 8-channel passive filter network with ESD protection

Rev. 2 — 5 May 2011

**Product data sheet** 

### 1. Product profile

### **1.1 General description**

The devices are 4-, 6- and 8-channel RC low-pass filter arrays which are designed to provide filtering of undesired RF signals on the I/O ports of portable communication or computing devices. In addition, the devices incorporate diodes to provide protection to downstream components from ElectroStatic Discharge (ESD) voltages as high as  $\pm 30$  kV.

The devices are fabricated using monolithic silicon technology and integrate up to eight resistors and sixteen diodes in a 0.4 mm pitch 8-, 12- or 16-pin ultra-thin leadless Quad Flat No-leads (QFN) plastic package with a height of 0.55 mm only.

#### 1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- 4-, 6- and 8-channel integrated  $\pi$ -type RC filter network
- ESD protection to ±30 kV contact discharge according to IEC 61000-4-2 far exceeding level 4
- QFN plastic package with 0.4 mm pitch and 0.55 mm height

#### **1.3 Applications**

General-purpose ElectroMagnetic Interference (EMI) and Radio-Frequency Interference (RFI) filtering and downstream ESD protection for:

- Cellular phone and Personal Communication System (PCS) mobile handsets
- Cordless telephones
- Wireless data (WAN/LAN) systems
- Mobile Internet Devices (MID)
- Portable Media Players (PMP)



### Integrated 4-, 6- and 8-channel passive filter network

### 1.4 Quick reference data

Table 1.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IP4251C2	28-4-TTL; IP4251CZ12-6-T	L; IP4251CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz; V <sub>bias(DC)</sub> = 2.5 V	[1]	-	10	-	pF
R <sub>s(ch)</sub>	channel series resistance			80	100	120	Ω
IP4252C2	28-4-TTL; IP4252CZ12-6-T	L; IP4252CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz; V <sub>bias(DC)</sub> = 2.5 V	<u>[1]</u>	-	12	-	pF
R <sub>s(ch)</sub>	channel series resistance			32	40	48	Ω
IP4253C2	28-4-TTL; IP4253CZ12-6-T	L; IP4253CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz; V <sub>bias(DC)</sub> = 2.5 V	<u>[1]</u>	-	30	-	pF
R <sub>s(ch)</sub>	channel series resistance			160	200	240	Ω
IP4254C2	28-4-TTL; IP4254CZ12-6-T	L; IP4254CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz; V <sub>bias(DC)</sub> = 2.5 V	<u>[1]</u>	-	30	-	pF
R <sub>s(ch)</sub>	channel series resistance			80	100	120	Ω

## 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
IP4251CZ8-4	-TTL; IP4252CZ8	-4-TTL; IP4253CZ8-4-	TTL; IP4254CZ8-4-TTL (SOT1166-1)
1 and 8	filter channel 1		_
2 and 7	filter channel 2	- <u>8</u> 5	R <sub>s(ch)</sub> 1 to 4
3 and 6	filter channel 3		$\mathbf{x} = \frac{\mathbf{c}_{ch}}{2} = \frac{\mathbf{c}_{ch}}{2} \mathbf{x}$
4 and 5	filter channel 4		
ground pad	ground	Transparent top view	, , GND 018aaa07
IP4251CZ12	-6-TTL; IP4252CZ	12-6-TTL; IP4253CZ12	2-6-TTL; IP4254CZ12-6-TTL (SOT1167-
1 and 12	filter channel 1		_
2 and 11	filter channel 2	- 12 7	1 to 6 + 7 to 1
3 and 10	filter channel 3		$\pm \pm \frac{c_{ch}}{2} \pm \frac{c_{ch}}{2} \pm$
4 and 9	filter channel 4	1 6	
5 and 8	filter channel 5	Transparent top view	
6 and 7	filter channel 6		018aaa0
ground pad	ground		

### Integrated 4-, 6- and 8-channel passive filter network

Table 2. P	inningcontinued	1	
Pin	Description	Simplified outline	Graphic symbol
IP4251CZ16-	-8-TTL; IP4252CZ	16-8-TTL; IP4253CZ16-	-8-TTL; IP4254CZ16-8-TTL (SOT1168-1)
1 and 16	filter channel 1		-
2 and 15	filter channel 2	- 16 9	R <sub>s(ch)</sub> 1 to 8 - + + 9 to 16
3 and 14	filter channel 3		$\frac{1}{2}$
4 and 13	filter channel 4	1 8	
5 and 12	filter channel 5	Transparent top view	
6 and 11	filter channel 6		018aaa073
7 and 10	filter channel 7		
8 and 9	filter channel 8		
ground pad	ground		

## 3. Ordering information

Table 3. Ordering	g information		
Type number	Package		
	Name	Description	Version
IP4251CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1.7 $\times$ 0.55 mm	SOT1166-1
IP4251CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 $\times$ 2.5 $\times$ 0.55 mm	SOT1167-1
IP4251CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 $\times$ 3.3 $\times$ 0.55 mm	SOT1168-1
IP4252CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1.7 $\times$ 0.55 mm	SOT1166-1
IP4252CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 $\times$ 2.5 $\times$ 0.55 mm	SOT1167-1
IP4252CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 $\times$ 3.3 $\times$ 0.55 mm	SOT1168-1
IP4253CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1.7 $\times$ 0.55 mm	SOT1166-1
IP4253CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 $\times$ 2.5 $\times$ 0.55 mm	SOT1167-1
IP4253CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 $\times$ 3.3 $\times$ 0.55 mm	SOT1168-1
IP4254CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1.7 $\times$ 0.55 mm	SOT1166-1
IP4254CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 $\times$ 2.5 $\times$ 0.55 mm	SOT1167-1
IP4254CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 $\times$ 3.3 $\times$ 0.55 mm	SOT1168-1

#### Integrated 4-, 6- and 8-channel passive filter network

## 4. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
IP4251CZ	28-4-TTL; IP4251CZ12-6-TT	L; IP4251CZ16-8-TTL			
V <sub>ESD</sub>	electrostatic discharge voltage	all pins to ground; contact discharge	<u>[1]</u> -	±15	kV
IP4252CZ	28-4-TTL; IP4252CZ12-6-TT	L; IP4252CZ16-8-TTL			
V <sub>ESD</sub>	electrostatic discharge voltage	all pins to ground; contact discharge	[1] -	±15	kV
IP4253CZ	8-4-TTL; IP4253CZ12-6-TT	L; IP4253CZ16-8-TTL			
V <sub>ESD</sub>	electrostatic discharge voltage	all pins to ground	[2]		
		contact discharge	-	±30	kV
		air discharge	-	±30	kV
IP4254CZ	28-4-TTL; IP4254CZ12-6-TT	L; IP4254CZ16-8-TTL			
LOD	electrostatic discharge voltage	all pins to ground	[2]		
		contact discharge	-	±30	kV
		air discharge	-	±30	kV
Per devic	e				
V <sub>ESD</sub> electrostatic discharge voltage		IEC 61000-4-2, level 4; all pins to ground			
		contact discharge	-	±8	kV
		air discharge	-	±15	kV
V <sub>CC</sub>	supply voltage		-0.5	+5.6	V
P <sub>ch</sub>	channel power dissipation	T <sub>amb</sub> = 85 °C	-	60	mW
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 85 °C	-	200	mW
T <sub>stg</sub>	storage temperature		-55	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C

 Device tested with 1000 pulses of ±15 kV contact discharges, according to the IEC 61000-4-2 model, far exceeding IEC 61000-4-2 level 4 (8 kV contact discharge).

[2] Device tested with 1000 pulses of ±30 kV contact discharges, according to the IEC 61000-4-2 model, far exceeding IEC 61000-4-2 level 4 (8 kV contact discharge).

### Integrated 4-, 6- and 8-channel passive filter network

## 5. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IP4251C2	28-4-TTL; IP4251CZ12-6-T	TL; IP4251CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz	[1]				
		$V_{bias(DC)} = 2.5 V$		-	10	-	pF
		$V_{bias(DC)} = 0 V$	[2]	-	15	-	pF
R <sub>s(ch)</sub>	channel series resistance			80	100	120	Ω
IP4252C2	28-4-TTL; IP4252CZ12-6-T	TL; IP4252CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz	[1]				
		$V_{bias(DC)} = 2.5 V$		-	12	-	pF
		$V_{bias(DC)} = 0 V$	[2]	-	18	-	pF
R <sub>s(ch)</sub>	channel series resistance			32	40	48	Ω
IP4253C2	28-4-TTL; IP4253CZ12-6-T	TL; IP4253CZ16-8-TTL					
C <sub>ch</sub> channel capacitance	channel capacitance	f = 100 kHz	[1]				
	$V_{bias(DC)} = 2.5 V$		-	30	-	pF	
	$V_{bias(DC)} = 0 V$	[2]	-	45	-	pF	
R <sub>s(ch)</sub>	channel series resistance			160	200	240	Ω
IP4254C2	28-4-TTL; IP4254CZ12-6-T	TL; IP4254CZ16-8-TTL					
C <sub>ch</sub>	channel capacitance	f = 100 kHz	[1]				
		$V_{bias(DC)} = 2.5 V$		-	30	-	pF
		$V_{bias(DC)} = 0 V$	[2]	-	45	-	pF
R <sub>s(ch)</sub>	channel series resistance			80	100	120	Ω
Per devic	e						
I <sub>LR</sub>	reverse leakage current	per channel; $V_I = 3.5 V$		-	-	0.1	μΑ
V <sub>BR</sub>	breakdown voltage	positive clamp; I <sub>I</sub> = 1 mA		5.8	-	9	V
V <sub>F</sub>	forward voltage	negative clamp; I <sub>F</sub> = 1 mA		0.4	-	1.5	V

[1] For the total channel.

[2] Guaranteed by design.

### Integrated 4-, 6- and 8-channel passive filter network

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
IP4251C2	28-4-TTL; IP4251CZ12-6-	TTL; IP4251CZ16-8-TTL				
$\alpha_{il}$	insertion loss	$R_{source}$ = 50 $\Omega$ ; $R_{L}$ = 50 $\Omega$				
		800 MHz < f < 3 GHz	-	16	-	dB
	f = 1 GHz	-	20	-	dB	
$\alpha_{ct}$	crosstalk attenuation	$R_{source}$ = 50 Ω; $R_{L}$ = 50 Ω; 800 MHz < f < 3 GHz	-	30	-	dB
IP4252C2	28-4-TTL; IP4252CZ12-6-	TTL; IP4252CZ16-8-TTL				
$\alpha_{il}$ insertion loss	insertion loss	$R_{source} = 50 \ \Omega; R_L = 50 \ \Omega$				
		800 MHz < f < 3 GHz	-	12	-	dB
		f = 1 GHz	-	14	-	dB
$\alpha_{ct}$	crosstalk attenuation	$R_{source}$ = 50 Ω; $R_{L}$ = 50 Ω; 800 MHz < f < 3 GHz	-	40	-	dB
IP4253C2	28-4-TTL; IP4253CZ12-6-	TTL; IP4253CZ16-8-TTL				
$\alpha_{il}$ insertion loss	insertion loss	$R_{source}$ = 50 $\Omega$ ; $R_{L}$ = 50 $\Omega$				
		800 MHz < f < 3 GHz	-	33	-	dB
		f = 1 GHz	35	-	-	dB
$\alpha_{ct}$	crosstalk attenuation	$R_{source}$ = 50 Ω; $R_{L}$ = 50 Ω; 800 MHz < f < 3 GHz	-	30	-	dB
IP4254C2	28-4-TTL; IP4254CZ12-6-	TTL; IP4254CZ16-8-TTL				
$\alpha_{il}$	insertion loss	$R_{source}$ = 50 $\Omega$ ; $R_{L}$ = 50 $\Omega$				
		800 MHz < f < 3 GHz	-	28	-	dB
		f = 1 GHz	30	-	-	dB
$\alpha_{ct}$	crosstalk attenuation	$R_{source} = 50 \Omega; R_{L} = 50 \Omega;$	-	30	-	dB

#### Table 6. Frequency characteristics

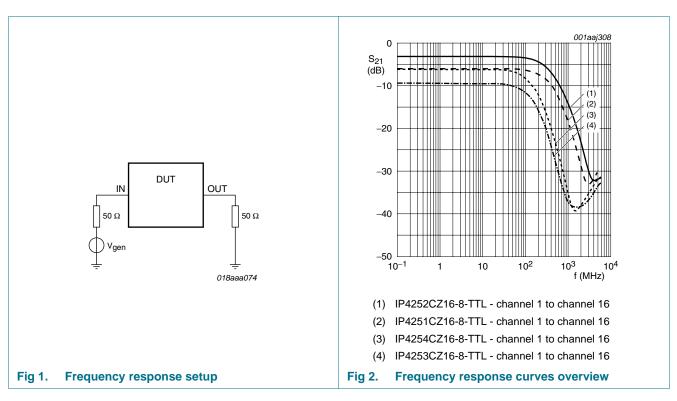
Integrated 4-, 6- and 8-channel passive filter network

## 6. Application information

#### 6.1 Insertion loss

The devices are designed as EMI/RFI filters for multichannel interfaces.

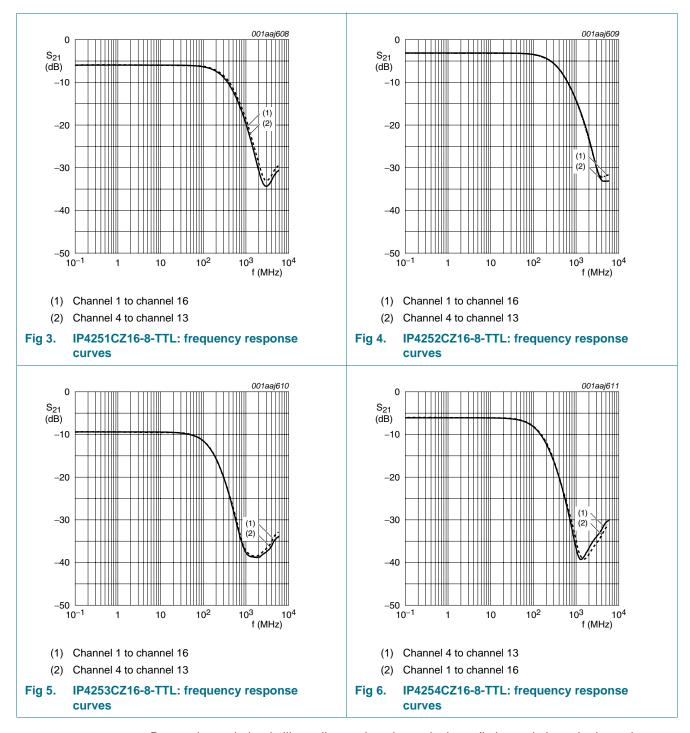
The block schematic for measuring insertion loss in a 50  $\Omega$  system is shown in Figure 1. Typical measurements results are shown in Figure 2 to Figure 6 for the different devices.



### **NXP Semiconductors**

# IP4251/52/53/54-TTL

Integrated 4-, 6- and 8-channel passive filter network



Due to the optimized silicon dice and package design, all channels in a single package show a very good matching performance as the insertion loss for a channel at the package side (e.g. channel 1 to channel 16) is nearly identical with the center channels (e.g. channel 4 to channel 13).

#### 6.2 Selection

The selection of one of the filter devices has to be performed depending on the maximum clock frequency, driver strength, capacitive load of the sink, and also the maximum applicable rise and fall times.

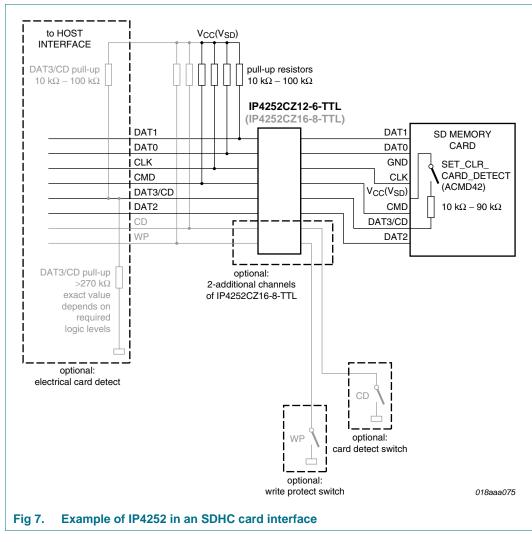
#### 6.2.1 SDHC and MMC memory interface

The Secure Digital High Capacity (SDHC) memory card interface standard specification and the Multi Media Card (MMC) (JESD 84A43) standard specification recommend a rise and fall time of 25 % to 62.5 % (62.5 % to 25 % respectively) of 3 ns or less for the input signal of the receiving interface side.

Assuming a typical capacitance of about 20 pF for the SDHC memory card itself, and approximately 4 pF to 7 pF for the Printed-Circuit Board (PCB) and the card holder, IP4252CZ12-6-TTL (6 channels,  $R_{s(ch)} = 40 \Omega$ ,  $C_{ch} = 12 \text{ pF}$  at  $V_{bias(DC)} = 2.5 \text{ V}$ ) is a matching selection to filter and protect all relevant interface pins such as CLK, CMD, and DAT0 to DAT3/CD. Please refer to Figure 7 for a general example of the implementation of the device in an SDHC card interface.

In case additional channels such as write-protect or a mechanical card-detection switch are used, the IP4252CZ16-8-TTL (8 channels,  $R_{s(ch)} = 40 \Omega$ ,  $C_{ch} = 12 \text{ pF}$  at  $V_{bias(DC)} = 2.5 \text{ V}$ ) offers two additional channels.

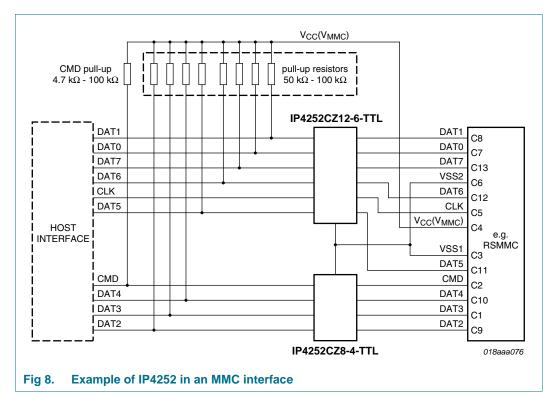
#### Integrated 4-, 6- and 8-channel passive filter network



The capacitance values specified for the signal channels of the MMC interface differ from the SDHC specification. The MMC card-side interface is specified to have an intrinsic capacitance of 12 pF to 18 pF and the total channel is limited according to the specification to 30 pF only. Therefore, any filter device capacitance is limited to a maximum of up to 18 pF, including the card holder and PCB traces.

Please refer to Figure 8 for a general example of the implementation of the IP4252 in an MMC interface application.

#### Integrated 4-, 6- and 8-channel passive filter network



To generate SDHC and MMC-compliant digital signals, the driver strength should not significantly undercut 8 mA.

#### 6.2.2 LCD interfaces, medium-speed interfaces

For digital interfaces such as LCD interfaces running at clock speeds between 10 MHz and 25 MHz or more, IP4251, IP4252 or IP4254 can be used depending on the sink load, clock speed, driver strength and rise and fall time requirements. Also the minimum EMI filter requirements may be a decision-making factor.

#### 6.2.3 Keypad, low-speed interfaces

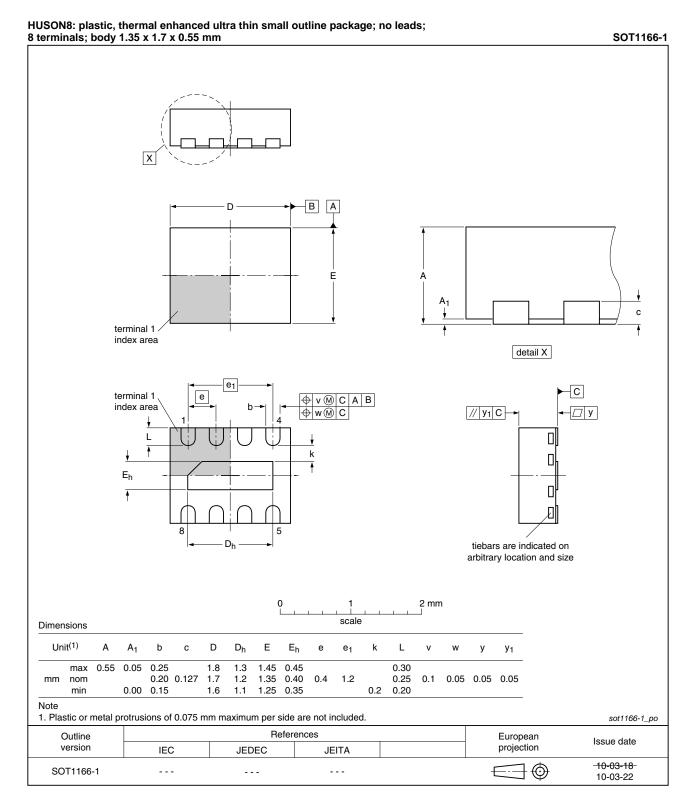
Especially for lower-speed interfaces such as keypads, low-speed serial interfaces (e.g. Recommended Standard (RS) 232) and low-speed control signals, IP4253 ( $R_{s(ch)} = 200 \ \Omega$ ,  $C_{ch} = 30 \ pF$  at  $V_{bias(DC)} = 2.5 \ V$ ) offers a very robust ESD protection and strong suppression of unwanted frequencies (EMI filtering).

#### **NXP Semiconductors**

## IP4251/52/53/54-TTL

Integrated 4-, 6- and 8-channel passive filter network

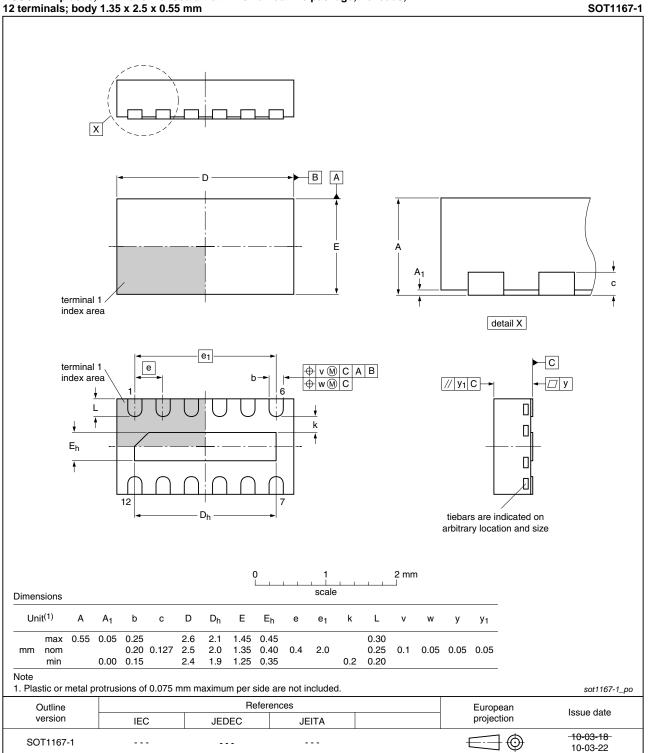
## 7. Package outline



#### Fig 9. Package outline SOT1166-1 (HUSON8)

All information provided in this document is subject to legal disclaimers.

Integrated 4-, 6- and 8-channel passive filter network

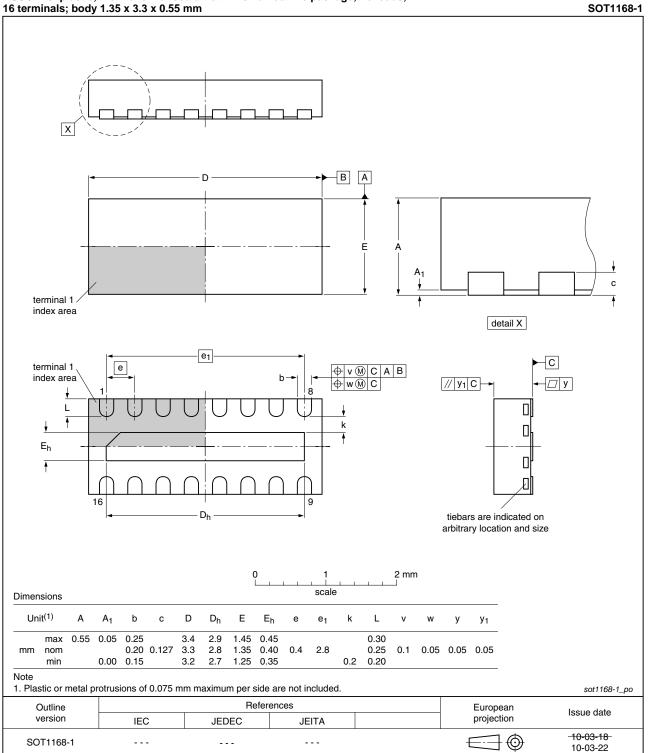


# HUSON12: plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 x 2.5 x 0.55 mm

Fig 10. Package outline SOT1167-1 (HUSON12)

All information provided in this document is subject to legal disclaimers.

Integrated 4-, 6- and 8-channel passive filter network



# HUSON16: plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 x 3.3 x 0.55 mm

Fig 11. Package outline SOT1168-1 (HUSON16)

All information provided in this document is subject to legal disclaimers.

### Integrated 4-, 6- and 8-channel passive filter network

## 8. Revision history

### Table 7.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4251_52_53_54-TTL v.2	20110505	Product data sheet	-	IP4251_52_53_54-TTL v.1
Modifications:	Section 1 "Pro	oduct profile": updated.		
	Table 2 "Pinnii	ng": updated.		
	<ul> <li>Deleted section</li> </ul>	on "Thermal characteristics"		
IP4251_52_53_54-TTL v.1	20110131	Objective data sheet	-	-

Integrated 4-, 6- and 8-channel passive filter network

### 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 9.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 9.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

#### Integrated 4-, 6- and 8-channel passive filter network

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the

### **10. Contact information**

product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

### 9.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

### Integrated 4-, 6- and 8-channel passive filter network

### **11. Contents**

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
1.4	Quick reference data 2
2	Pinning information 2
3	Ordering information 3
4	Limiting values 4
5	Characteristics 5
6	Application information 7
6.1	Insertion loss 7
6.2	Selection
6.2.1	SDHC and MMC memory interface 9
6.2.2	LCD interfaces, medium-speed interfaces 11
6.2.3	Keypad, low-speed interfaces 11
7	Package outline 12
8	Revision history 15
9	Legal information 16
9.1	Data sheet status 16
9.2	Definitions 16
9.3	Disclaimers
9.4	Trademarks 17
10	Contact information 17
11	Contents 18

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 5 May 2011 Document identifier: IP4251\_52\_53\_54-TTL